MMBD452LT1G

Dual Hot-Carrier Diodes

Schottky Barrier Diodes

These devices are designed primarily for high-efficiency UHF and VHF detector applications. They are readily adaptable to many other fast switching RF and digital applications. They are supplied in an inexpensive plastic package for low-cost, high-volume consumer and industrial/commercial requirements.

Features

- Extremely Low Minority Carrier Lifetime
- Very Low Capacitance
- Low Reverse Leakage
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS ($T_J = 125^{\circ}C$ unless otherwise noted)

| Rating | Symbol | Value | Unit | |
|---|------------------|-------------|-------------|--|
| Reverse Voltage | V _R | 30 | V | |
| Forward Power Dissipation @ T _A = 25°C Derate above 25°C | P _F | 225 1.8 | mW mW/°C | |
| Operating Junction Temperature Range | TJ | -55 to +125 | °C | |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C | |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (EACH DIODE)

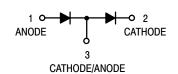
| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------------------|-----|------|------|------|
| Reverse Breakdown Voltage (I _R = 10 μA) | V _{(BR)R} | 30 | - | - | V |
| Total Capacitance (V _R = 15 V, f = 1.0 MHz) Figure 1 | C _T | - | 0.9 | 1.5 | pF |
| Reverse Leakage (V _R = 25 V) Figure 3 | I _R | - | 13 | 200 | nAdc |
| Forward Voltage (I _F = 1.0 mAdc) Figure 4 | V _F | - | 0.38 | 0.45 | Vdc |
| Forward Voltage (I _F = 10 mAdc) Figure 4 | V _F | - | 0.52 | 0.6 | Vdc |



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30 VOLTS DUAL HOT-CARRIER DETECTOR AND SWITCHING DIODES





SOT-23 (TO-236) CASE 318 STYLE 11

MARKING DIAGRAM



5N = Device Code M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------|---------------------|-----------------------|
| MMBD452LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

1

MMBD452LT1G

TYPICAL ELECTRICAL CHARACTERISTICS

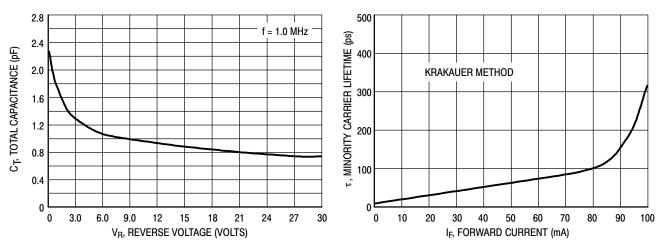


Figure 1. Total Capacitance

Figure 2. Minority Carrier Lifetime

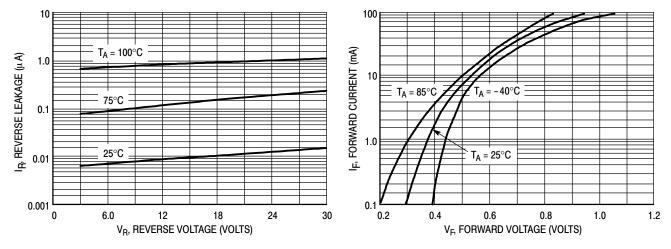


Figure 3. Reverse Leakage

Figure 4. Forward Voltage

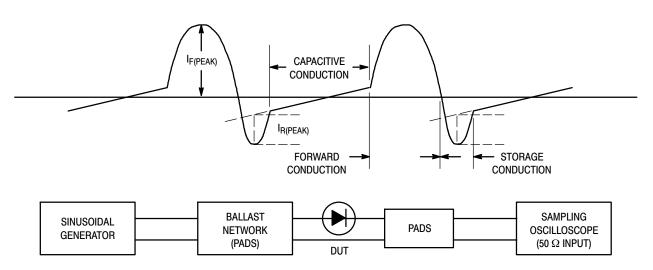
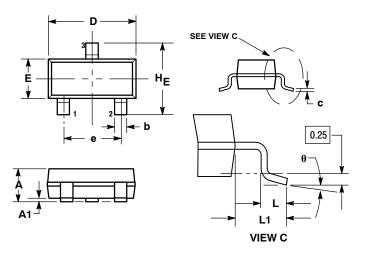


Figure 5. Krakauer Method of Measuring Lifetime

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PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AN



NOTES:

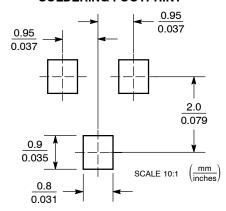
- DIMENSIONING AND TOLERANCING PER ANSI
 MARKET AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

| | MILLIMETERS | | | | INCHES | IES |
|-----|-------------|------|------|-------|--------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.040 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.018 | 0.020 |
| С | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| е | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.081 |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |

STYLE 11:

- PIN 1. ANODE
- CATHODE
 CATHODE-ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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